

# PROCEEDINGS OF SPIE

## ***Lasers in Material Processing and Manufacturing III***

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*Editors*

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# Contents

- ix *Conference Committee*  
xi *Symposium Committees*

---

## SESSION 1 LASER-INDUCED REMOVAL OF MATERIALS I

---

- 6825 02 **Plasma light emission monitoring and penetration status recognition in CO<sub>2</sub> laser welding of AZ31B wrought magnesium alloy (Invited Paper)** [6825-31]  
W. Tan, Tsinghua Univ. (China); J. Shan, Tsinghua Univ. (China) and Key Lab. for Advanced Materials Processing Technology, Ministry of Education (China); X. Lei, J. Zhang, W. Chen, J. Ren, Tsinghua Univ. (China)
- 6825 03 **Quality control of laser tailor welded blanks (Invited Paper)** [6825-42]  
Q. Yan, Baoshan Iron and Steel Corp. (China)
- 6825 04 **Study on process stability and seam characteristics of high power laser welding with filling wire for high thickness steel (Invited Paper)** [6825-54]  
Y. Cai, G. Li, J. Huang, L. Zhao, Y. Wu, Shanghai Jiao Tong Univ. (China) and Shanghai Key Lab. of Materials Laser Processing and Modification (China)
- 6825 05 **Laser beam welding of aluminum alloys (Invited Paper)** [6825-63]  
R. Xiao, Beijing Univ. of Technology (China)
- 6825 06 **Morphology and mechanical characteristics of pulse laser coating-texturing WC-Ni alloying layers** [6825-39]  
D. Wan, H. Liu, D. Hu, L. Cai, Shanghai Jiaotong Univ. (China)
- 6825 07 **Boundary coupled dual-equation numerical simulation on mass transfer in the process of laser cladding** [6825-40]  
Y. Huang, Y. Yang, G. Wei, South China Univ. of Technology (China); G. Liang, Xi'an Jiaotong Univ. (China)
- 6825 08 **Mechanism of CO<sub>2</sub> laser cutting nonmetallic materials based on wall focusing effects** [6825-43]  
X. Xie, Guangdong Univ. of Technology (China); L. Li, Hunan Univ. (China); X. Wei, W. Hu, Guangdong Univ. of Technology (China)
- 6825 09 **A study on laser weldability and formability of high thickness ratio tailor welded blanks** [6825-44]  
G. Wang, G. Li, Y. Cai, X. Hua, Y. Wu, Shanghai Jiaotong Univ. (China)
- 6825 0A **Influence of beam spatial distribution on the laser damage of optical material** [6825-55]  
L. Qi, X. Zhu, C. Zhu, G. Zhu, T. Yang, Huazhong Univ. of Science and Technology (China)

- 6825 0B **Laser welding of automobile double-linked gears** [6825-59]  
Y. Wang, X. Yang, J. Lei, Tianjin Polytechnic Univ. (China); C. Zhao, H. Bi, Tianjin Automobile Gear Factory (China)

---

**SESSION 2 LASER-INDUCED REMOVAL OF MATERIALS II**

---

- 6825 0C **One-step shaping of NiTi biomaterial by selective laser melting** [6825-37]  
Y. Yang, Y. Huang, W. Wu, South China Univ. of Technology (China)
- 6825 0D **Ceramics reinforced metal base composite coatings produced by CO<sub>2</sub> laser cladding (Invited Paper)** [6825-58]  
X. Yang, Y. Wang, N. Yang, Tianjin Polytechnic Univ. (China)
- 6825 0F **Technological study of oxygen aided laser cutting silicon steel** [6825-01]  
L. Hong, C. Mi, G. Wu, Shanghai Maritime Univ. (China)
- 6825 0G **Numerical analysis of cutting glass by dual CO<sub>2</sub>- laser beams** [6825-02]  
J. Jiao, X. Wang, X. Zhang, W. Tang, F. Liu, Y. Lu, Huazhong Univ. of Science and Technology (China)
- 6825 0H **Optimization of laser processing techniques and parameters for laser transformation hardening with multi-objectives** [6825-08]  
G. Wu, L. Hong, Shanghai Maritime Univ. (China)
- 6825 0I **Fundamental microstructures fabricated on FOTURAN glass using femtosecond laser** [6825-13]  
Y. Wu, C. Wang, W. Jia, M. Hu, X. Ni, L. Chai, Tianjin Univ. (China)
- 6825 0J **Research of transparent materials bulk damage characteristics by using modulated laser pulse** [6825-56]  
G. Zhu, X. Zhu, L. Qi, C. Zhu, T. Yang, Huazhong Univ. of Science and Technology (China)

---

**SESSION 3 LASER-INDUCED DEPOSITION OF MATERIALS**

---

- 6825 0K **Femtosecond laser micromachining and microfabrication in transparent materials (Invited Paper)** [6825-19]  
Y. Li, D. Liu, F. Qi, H. Yang, Q. Gong, Peking Univ. (China)
- 6825 0L **Selective deposition of conductive copper films on glass surfaces using femtosecond laser surface modification and electroless plating** [6825-10]  
J. Xu, Y. Liao, Shanghai Institute of Optics and Fine Mechanics (China) and Graduate School of the Chinese Academy of Sciences (China); H. Zeng, East China Univ. of Science and Technology (China); Z. Zhou, H. Sun, Shanghai Institute of Optics and Fine Mechanics (China); J. Song, X. Wang, Shanghai Institute of Optics and Fine Mechanics (China) and Graduate School of the Chinese Academy of Sciences (China); Y. Cheng, Z. Xu, Shanghai Institute of Optics and Fine Mechanics (China); K. Sugioka, K. Midorikawa, Laser Technology Lab., RIKEN (Japan)

- 6825 0M **Transparent conducting  $\text{CuCr}_{1-x}\text{Mg}_x\text{O}_2$  films prepared by pulsed laser deposition** [6825-16]  
D. Li, X. Fang, R. Tao, W. Dong, Z. Deng, Anhui Institute of Optics and Fine Mechanics (China); X. Zhu, Institute of Solid State Physics (China)
- 6825 0N **Diamond-like carbon films deposited by femtosecond laser pulses** [6825-30]  
Y. Guo, Huazhong Univ. of Science and Technology (China) and Wuhan Ordnance Non-Commissioned Officers Academy (China); X. Yuan, Huazhong Univ. of Science and Technology (China); S. Wang, C. Lu, X. Wang, Y. Cheng, H. Cao, X. Liu, Wuhan Ordnance Non-Commissioned Officers Academy (China)
- 6825 0O **Improvement of nanosecond laser ablation quality by pulse shaping technique** [6825-36]  
X. D. Wang, Huazhong Univ. of Science and Technology (China); A. Michalowski, Univ. Stuttgart (Germany); S. L. Wang, J. S. Liu, Huazhong Univ. of Science and Technology (China); F. Dausinger, Univ. Stuttgart (Germany)
- 6825 0P **Research on the filter properties of the one-dimensional three sects photonic crystal with symmetrical structure** [6825-48]  
Z. Li, X. Tian, H. Wang, T. Zhang, Yanshan Univ. (China)
- 6825 0Q **1.31- $\mu\text{m}$  GaInNAs lasers fabricated with pulsed anodic oxidation** [6825-21]  
Y. Deng, Y. Qu, Z. Qiao, Changchun Univ. of Science and Technology (China); H. Zou, Jilin Univ. (China); Y. Wang, Z. Li, Changchun Univ. of Science and Technology (China)

---

#### SESSION 4 INDUSTRIAL SYSTEMS

---

- 6825 0W **Square laser beam of high power transverse flow  $\text{CO}_2$  laser and its application** [6825-29]  
Y. Qin, X. Tang, R. Zhong, Z. Li, Huazhong Univ. of Science and Technology (China)
- 6825 0X **Powder flow field distribution with different parameters in coaxial laser cladding** [6825-60]  
N. Yang, X. Yang, Tianjin Polytechnic Univ. (China)
- 6825 0Y **Supercontinuum generation in photonics crystal fibers with a femtosecond pulse** [6825-49]  
S. Zhang, X. Meng, G. Zhao, Z. Zhang, Hebei Normal Univ. (China); F. Lu, Nankai Univ. (China); Y. Gong, X. Yang, Institute for Infocomm Research (Singapore)
- 6825 0Z **A tunable erbium-doped fiber laser with power-equalized output using nonlinear polarization rotation** [6825-50]  
S. Zhang, D. Li, X. Li, Z. Yang, Hebei Normal Univ. (China)

---

#### POSTER SESSION

---

- 6825 10 **Application of the machine CNC system in laser marking** [6825-03]  
W. Zhao, Tianjin Univ. of Technology and Education (China); Y. Sa, Tianjin Univ. (China); X. Liu, N. Feng, Tianjin Univ. of Technology and Education (China)
- 6825 11 **A novel differential optical beam deflection detection system for measuring laser-generated surface acoustic waves** [6825-06]  
Y. Shi, Z. Shen, X. Ni, J. Lu, Nanjing Univ. of Science and Technology (China)

- 6825 12 **Numerical simulation of surface crack detection by laser-generated circumferential guided wave in elastic cylinders** [6825-07]  
Y. Shi, Z. Shen, X. Ni, J. Lu, Nanjing Univ. of Science and Technology (China)
- 6825 13 **Mechanical effects during pulsed laser and metals interaction in glycerol-water mixtures** [6825-09]  
X. M. Liu, J. He, J. Lu, X. W. Ni, Nanjing Univ. of Science and Technology (China)
- 6825 14 **Process investigation of a-Si:H thin films prepared by DC magnetron sputtering** [6825-11]  
C. Liu, Changchun Univ. of Science and Technology (China) and Jilin Normal Univ. (China); C. Wang, Jilin Normal Univ. (China); Y. Yao, Changchun Univ. of Science and Technology (China) and Jilin Normal Univ. (China); J. Zhang, Z. Qiao, B. Huang, Y. Wang, B. Bo, Changchun Univ. of Science and Technology (China)
- 6825 15 **Research on the laser lap welding of TC4 titanium alloy and L3 industrial pure aluminum dissimilar metal** [6825-14]  
S. Liu, J. Ni, X. Zhou, B. Wang, X. Zhang, Huazhong Univ. of Science and Technology (China)
- 6825 16 **Characteristics of high-peak pulsed laser induced damage to fibers** [6825-22]  
X. Zhao, Y. Gao, Institute of Electronic Engineering (China); M. Xu, W. Duan, H. Yu, China Academy of Engineering Physics (China)
- 6825 17 **Switch power supply of fast axial flow CO<sub>2</sub> laser for complex machining** [6825-24]  
B. Li, Y. Wang, F. Ding, Huazhong Univ. of Science and Technology (China)
- 6825 18 **Integrated control system of transverse flow CO<sub>2</sub> laser and its application** [6825-26]  
J. Liu, X. Tang, Y. Zhang, H. Peng, Y. Wang, Huazhong Univ. of Science and Technology (China)
- 6825 19 **The  $\mu\text{-Si}$  on plastic substrate crystallized by pulsed double-frequency YAG laser annealing** [6825-32]  
J. Li, Z. Meng, Y. Li, C. Wu, Nankai Univ. (China) and Tianjin Univ. (China); H. S. Kwok, The Hong Kong Univ. of Science and Technology (Hong Kong, China); S. Xiong, Nankai Univ. (China) and Tianjin Univ. (China)
- 6825 1A **Simulation of thermal stress in n-type diamond thin films prepared by CVD** [6825-34]  
Y. Wang, North China Electric Power Univ. (China); Q. Zhao, Hebei Univ. (China); Z. Zhao, North China Electric Power Univ. (China)
- 6825 1B **Process analysis of diamond ablation by 157nm laser** [6825-35]  
W. Li, D. Jiang, Y. Dai, M. Gao, Wuhan Univ. of Technology (China)
- 6825 1C **Thermal elasto-plastic stress analysis during laser heating of a metal plate** [6825-38]  
Y. Chen, J. Lu, X. Ni, Nanjing Univ. of Science and Technology (China)
- 6825 1D **Mechanical behavior study of laser-welded joints for DP steel** [6825-41]  
Q. Yan, Baoshan Iron and Steel Co., Ltd. (China) and Shanghai Jiaotong Univ. (China)
- 6825 1E **Study of temperature measurement with one-dimensional photonic crystal** [6825-47]  
H. Wang, K. Tong, W. Cui, Z. Li, Yanshan Univ. (China)

- 6825 1F **Design of detection system based on laser SAW** [6825-51]  
X. Feng, C. Chang, Wuhan Institute of Technology (China)
- 6825 1G **A novel material processing and manufacturing measurement system by using electronic datum** [6825-61]  
W. L. Bear, X.-W. Xiong, Wynn. Bear International Cutting-edge High-Tech Institute, Inc. (China); J. T. Roth, Pennsylvania State Univ.-Erie (USA); M. P. Schoen, Idaho State Univ. (USA)
- 6825 1I **Characteristics of CW/pulse discharge for high power transverse flow CO<sub>2</sub> laser and its application** [6825-25]  
H. Peng, X. Tang, F. Xia, J. Liu, Y. Wang, Huazhong Univ. of Science and Technology (China)
- 6825 1M **Plasma characterization of brass alloys by laser induced breakdown spectroscopy** [6825-53]  
Y. Li, Y. Lu, K. Cheng, J. Wu, R. Zheng, Ocean Univ. of China (China)
- 6825 1N **Laser remanufacturing technology and its applications** [6825-67]  
S. Dong, B. Xu, Z. Wang, Y. Ma, W. Liu, National Key Lab. for Remanufacturing (China)
- 6825 1O **Fabrication of SiO<sub>2</sub>-TiO<sub>2</sub> strip waveguides by laser direct writing** [6825-70]  
A. Li, Z. Wang, J. Liu, X. Zeng, Huazhong Univ. of Science and Technology (China);  
C. Wang, H. Chen, Institute of Semiconductors (China)
- 6825 1P **Investigation on tribological behavior of Fe-based alloy coating formed by laser cladding** [6825-68]  
L. Shen, Q. Zhang, J. Song, J. Liao, South China Normal Univ. (China)
- 6825 1Q **Control module design for CO<sub>2</sub> laser processing system based on WEB protocol** [6825-20]  
Y. Lu, Y. Wu, Z. Chen, Y. Zheng, H. Chen, R. Chen, Fujian Normal Univ. (China)

*Author Index*



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